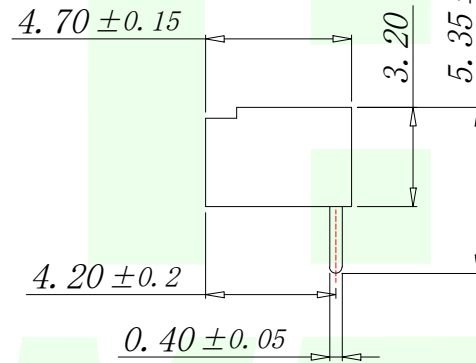
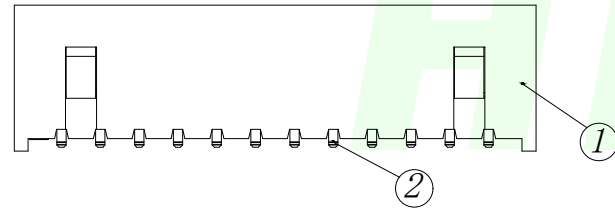
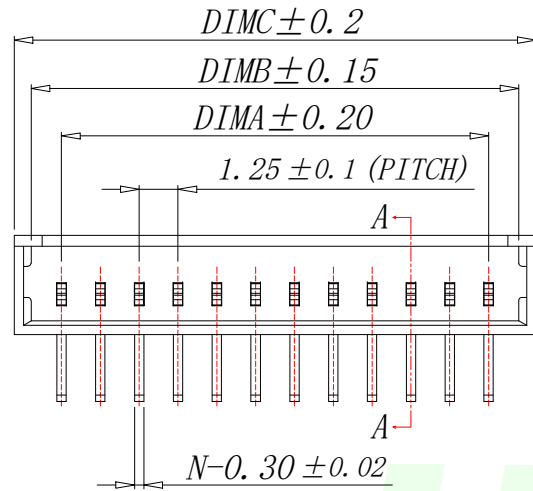
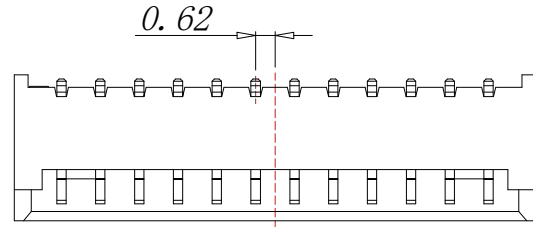


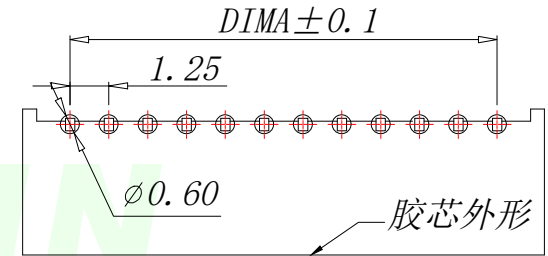
RoHs

Technical Index:

1. The surface of the plastic parts should be smooth, no rough edges, no obvious shrinkage, defects, cracks and other phenomena)
2. Lock Configuration: 2 to 3Pin is 1, ≥ 4 Pin is 2
3. Temperature range: $-25^{\circ}\text{C}\sim+85^{\circ}\text{C}$.
4. Rated voltage: 125V, AC/DC.
5. Contact resistance: $\leq 0.02\Omega$.
6. Insulation resistance: $\geq 100\text{M}\Omega$

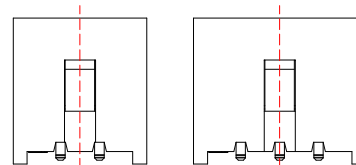


SECTION A-A



适用线路板 (PCB LAYOUT)

序号	品名	材质
1	1.25 Pitch R/A Wire To Board Housing DIP (H=3.2)	PA66 UL94V-2 Yellow
2	1.25 Pitch R/A Wire To Board Terminal DIP (H=3.2)	Copper Alloy/ Tin Plating



2 PIN

3 PIN

LOCK CONFIGURATION (锁扣位置)

GENERAL TOLERANCES
UNLESS SPECIFIED

X.° ±0.50	X.° ±5°
X.X° ±0.20	X.X° ±3°
X.XX° ±0.10	X.XX° ±1°

MANUFACTURE DWG

深圳市华明通电子有限公司
Shenzhen Huamingtong Electronics Co., LtdPART NO.
W1251100-XPY2123

DESIGN: James

CHED: Talen

APPD: Sophia

TITLE:
1.25 PITCH H3.2 R/A
WIRE TO BOARD DIP CONN.CUSTOMER
SIZE
A4UNITS
MM
SCALE
N:A
SHEET
1/1